COMPLIANT

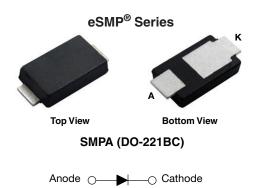
HALOGEN

FREE



## Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



### **LINKS TO ADDITIONAL RESOURCES**



| PRIMARY CHARACTERISTICS                                     |                 |  |  |  |
|---|-----------------|--|--|--|
| I <sub>F(AV)</sub>  | 4.0 A           |  |  |  |
| V <sub>RRM</sub>  | 50 V            |  |  |  |
| I <sub>FSM</sub>  | 80 A            |  |  |  |
| $V_F$ at $I_F = 4.0 \text{ A} (T_A = 125 ^{\circ}\text{C})$ | 0.46 V          |  |  |  |
| T <sub>J</sub> max.   | 150 °C          |  |  |  |
| Package   | SMPA (DO-221BC) |  |  |  |
| Circuit configuration                                       | Single          |  |  |  |

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- · Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### **TYPICAL APPLICATIONS**

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test **Polarity:** color band denotes cathode end

| MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)                   |                                   |             |      |  |
|---|-----------------------------------|-------------|------|--|
| PARAMETER   | SYMBOL                            | V4PAN50     | UNIT |  |
| Device marking code   |                                   | 4N5         |      |  |
| Maximum repetitive peak reverse voltage   | V <sub>RRM</sub>                  | 50          | V    |  |
| Maximum DC forward current  | I <sub>F</sub> <sup>(1)</sup>     | 4.0         | Α    |  |
|   | I <sub>F</sub> <sup>(2)</sup>     | 3.0         |      |  |
| Maximum DC reverse voltage  | V <sub>DC</sub>                   | 35          | V    |  |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>                  | 80          | А    |  |
| Operating junction and storage temperature range                                  | T <sub>J</sub> , T <sub>STG</sub> | -40 to +150 | °C   |  |

#### Notes

- (1) Units mounted on 15 mm x 15 mm pad areas, 2 oz. PCB
- (2) Free air, mounted on recommended copper pad area



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| <b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted) |                        |   |                               |      |      |      |
|---|------------------------|---|-------------------------------|------|------|------|
| PARAMETER   | TEST CONDITIONS        |   | SYMBOL                        | TYP. | MAX. | UNIT |
| Instantaneous forward voltage   | I <sub>F</sub> = 2.0 A | T <sub>A</sub> = 25 °C                            | V <sub>F</sub> <sup>(1)</sup> | 0.43 | -    | V    |
|   | I <sub>F</sub> = 4.0 A |   |                               | 0.51 | 0.59 |      |
|   | I <sub>F</sub> = 2.0 A | T <sub>A</sub> = 125 °C                           |                               | 0.34 | -    |      |
|   | I <sub>F</sub> = 4.0 A |   |                               | 0.46 | 0.54 |      |
| Reverse current   | V <sub>R</sub> = 35 V  | T <sub>A</sub> = 25 °C<br>T <sub>A</sub> = 125 °C | I <sub>R</sub> <sup>(2)</sup> | 8    | -    | μA   |
|   | V <sub>R</sub> = 33 V  | T <sub>A</sub> = 125 °C                           |                               | 8.8  | -    | mA   |
|   | V <sub>R</sub> = 50 V  | T <sub>A</sub> = 25 °C                            |                               | -    | 600  | μA   |
|   | v <sub>R</sub> = 50 v  | T <sub>A</sub> = 125 °C                           |                               | 12   | 35   | mA   |
| Typical junction capacitance  | 4.0 V, 1 MH            | 4.0 V, 1 MHz                                      |                               | 480  | -    | pF   |

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified) |                      |         |      |
|---|----------------------|---------|------|
| PARAMETER   | SYMBOL               | V4PAN50 | UNIT |
| Typical thermal resistance  | R <sub>0JA</sub> (1) | 100     | °C/W |
|   | R <sub>0JM</sub> (1) | 9       | ]    |

#### Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |  |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |  |
| V4PAN50-M3/I                   | 0.032           | I                      | 14 000        | 13" diameter plastic tape and reel |  |

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

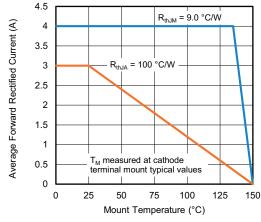


Fig. 1 - Maximum Forward Current Derating Curve

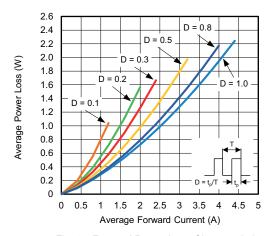


Fig. 2 - Forward Power Loss Characteristics



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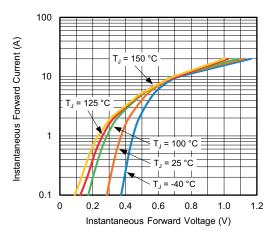


Fig. 3 - Typical Instantaneous Forward Characteristics

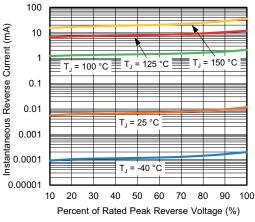


Fig. 4 - Typical Reverse Leakage Characteristics

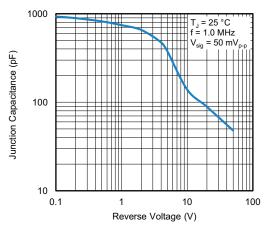


Fig. 5 - Typical Junction Capacitance

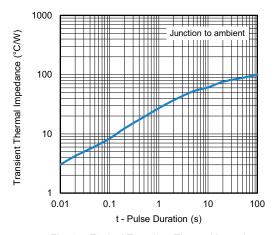


Fig. 6 - Typical Transient Thermal Impedance

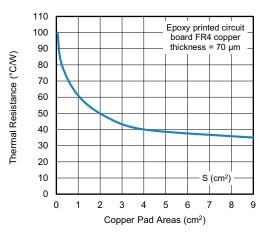


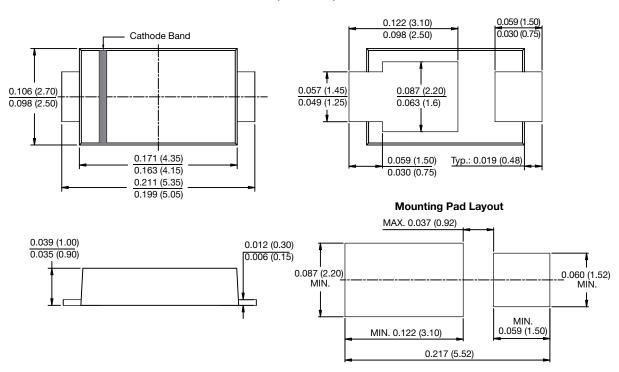
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### **SMPA (DO-221BC)**





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